KEMET Part Number: CBR06C130FAGAC



CBR-SMD RF C0G, Ceramic, 13 pF, 1%, 250 VDC, C0G, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



Dimensions	
Chip Size	0603
L	1.6mm +/-0.1mm
W	0.8mm +/-0.1mm
т	0.8mm +/-0.07mm
В	0.4mm +/-0.15mm

Packaging Specifications		
Packaging:	T&R, 180mm, Plastic Tape	
Packaging Quantity:	4000	

General Information	
Series:	CBR-SMD RF C0G
Style:	SMD Chip
Description:	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features:	Ultra High Q, Low ESR, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
AEC-Q200:	No
Notes:	Solder Wave or Solder Reflow.
Shelf Life:	78 Weeks
MSL:	1

Specifications		
Capacitance:	13 pF	
Capacitance Tolerance:	1%	
Voltage DC:	250 VDC	
Dielectric Withstanding Voltage:	500 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	COG	
Dissipation Factor:	0.152%	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	10 GOhms	
Quality Factor:	660	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.



单击下面可查看定价,库存,交付和生命周期等信息

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